

SB15L50

Reverse Voltage - 50 V

Forward Current - 15 A

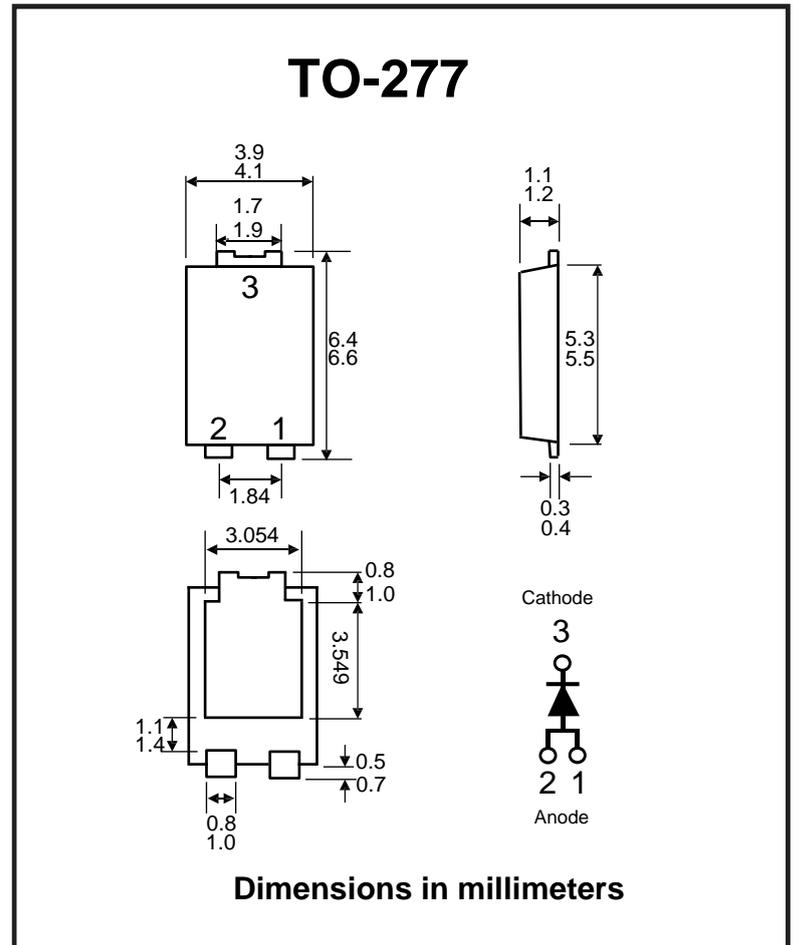
FEATURES

- ◆ Advanced trench technology
- ◆ Low forward voltage drop
- ◆ Low power losses
- ◆ High efficiency operation
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆ Case: TO-277
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026

Trench MOSFET Barrier Schottky Rectifier



Maximum Ratings (Per Leg) at Ta=25°C unless otherwise specified

Parameter	Symbols	Value	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	V
Maximum RMS voltage	V_{RMS}	50	V
Maximum DC Blocking Voltage	V_{DC}	50	V
Maximum Average Forward Rectified Current	Per diode $I_{F(AV)}$	15	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave superimposed on rated load per diode	I_{FSM}	280	A
Operating Temperature Range	T_J	-55 ~ +150	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	°C
Typical Thermal Resistance Per diode (mounted on FR-4 PCB)	TO-277 $R_{\theta JC}$	72	°C/W

Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

Electrical Characteristics (Per Leg) unless otherwise specified

Characteristics		Symbols	Value		Units
Forward Voltage Drop(Note2)		V_F	Typ	Max	V
at $I_F=5A$ Instantaneous forward voltage per diode	$T_A=25^{\circ}C$		0.40	-	
	$T_A=125^{\circ}C$		0.29	-	
at $I_F=15A$ Instantaneous forward voltage per diode	$T_A=25^{\circ}C$		0.48	0.52	
	$T_A=125^{\circ}C$	0.39	-		
Instantaneous reverse current per diode at rated reverse voltage	$T_A=25^{\circ}C$	I_R	20	60	μA
	$T_A=125^{\circ}C$		-	30	mA

Note2: (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: Pulse width ≤ 40 ms

RATINGS AND CHARACTERISTIC CURVES

